

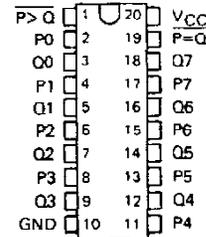
SN54LS682, SN54LS684, SN54LS685, SN54LS687, SN54LS688, SN74LS682, SN74LS684 THRU SN74LS688 8-BIT MAGNITUDE/IDENTITY COMPARATORS

D2617, JANUARY 1981—REVISED MARCH 1988

SDLS008

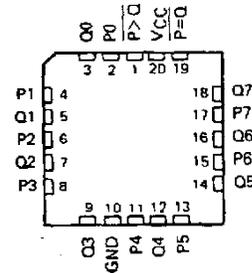
- Compares Two-8-Bit Words
- Choice of Totem-Pole or Open-Collector Outputs
- Hysteresis at P and Q Inputs
- 'LS682 has 20-kΩ Pullup Resistors on the Q Inputs
- SN74LS686 and 'LS687 . . . JT and NT 24-Pin, 300-Mil Packages

SN54LS682, SN54LS684, SN54LS685 . . . J PACKAGE
SN74LS682, SN74LS684, SN74LS685 . . . DW OR N PACKAGE
(TOP VIEW)

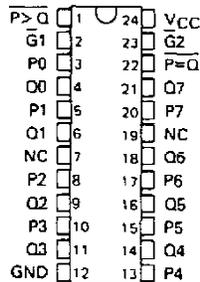


TYPE	P = Q	P > Q	OUTPUT ENABLE	OUTPUT CONFIGURATION	20-kΩ PULLUP
'LS682	yes	yes	no	totem-pole	yes
'LS684	yes	yes	no	totem-pole	no
'LS685	yes	yes	no	open-collector	no
SN74LS686	yes	yes	yes	totem-pole	no
'LS687	yes	yes	yes	open-collector	no
'LS688	yes	no	yes	totem-pole	no

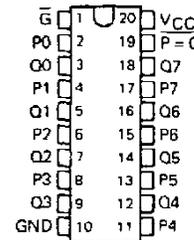
SN54LS682, SN54LS684, SN54LS685 . . . FK PACKAGE
(TOP VIEW)



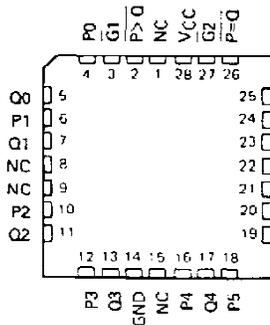
SN54LS687 . . . JT PACKAGE
SN74LS686, SN74LS687 . . . DW OR NT PACKAGE
(TOP VIEW)



SN54LS688 . . . J PACKAGE
SN74LS688 . . . DW OR N PACKAGE
(TOP VIEW)

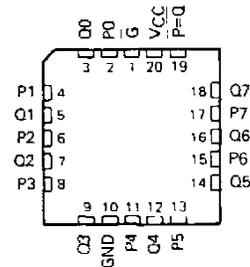


SN54LS687 . . . FK PACKAGE
(TOP VIEW)



NC—No internal connection

SN54LS688 . . . FK PACKAGE
(TOP VIEW)



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SN54LS682, SN54LS684, SN54LS685, SN54LS687, SN54LS688 SN74LS682, SN74LS684 THRU SN74LS688 8-BIT MAGNITUDE/IDENTITY COMPARATORS

description

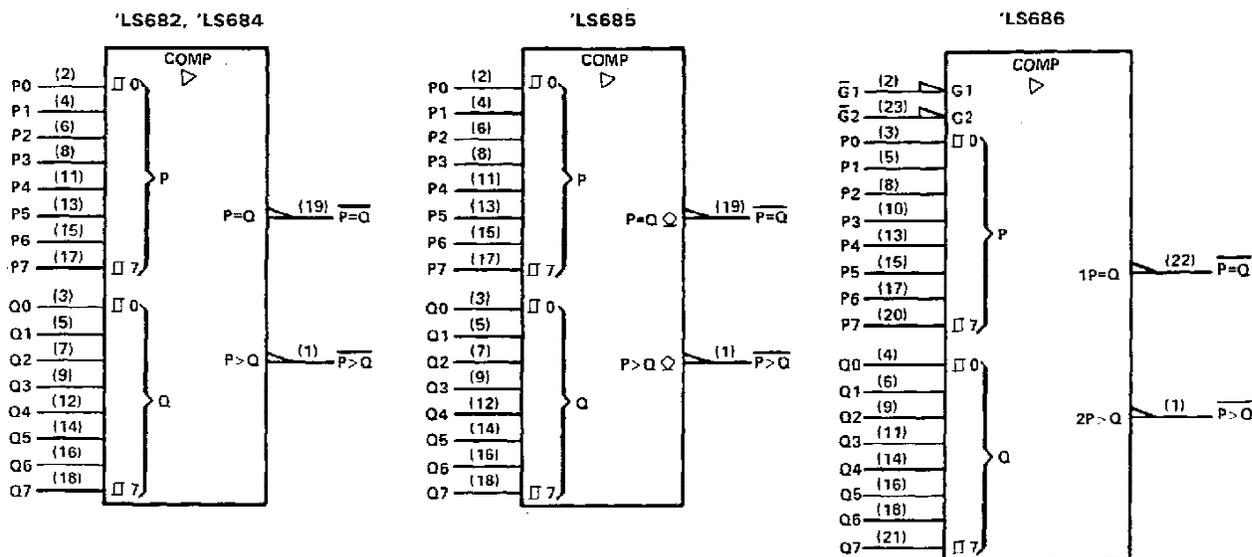
These magnitude comparators perform comparisons of two eight-bit binary or BCD words. All types provide $\overline{P=Q}$ outputs and all except 'LS688 provide $\overline{P>Q}$ outputs as well. The 'LS682, 'LS684, 'LS686, and 'LS688 have totem-pole outputs, while the 'LS685 and 'LS687 have open-collector outputs. The 'LS682 features 20-k Ω pullup termination resistors on the Q inputs for analog or switch data.

FUNCTION TABLE

DATA P, Q	ENABLES		OUTPUTS	
	$\overline{G1}$, $\overline{G1}$	$\overline{G2}$	$\overline{P=Q}$	$\overline{P>Q}$
P=Q	L	X	L	H
P>Q	X	L	H	L
P<Q	X	X	H	H
P=Q	H	X	H	H
P>Q	X	H	H	H
X	H	H	H	H

- NOTES: 1. The last three lines of the function table applies only to the devices having enable inputs, i.e., 'LS686 thru 'LS688.
2. The $\overline{P<Q}$ function can be generated by applying the $\overline{P=Q}$ and $\overline{P>Q}$ outputs to a 2-input NAND gate.
3. For 'LS686 and 'LS687, $\overline{G1}$ enables $\overline{P=Q}$ and $\overline{G2}$ enables $\overline{P>Q}$.

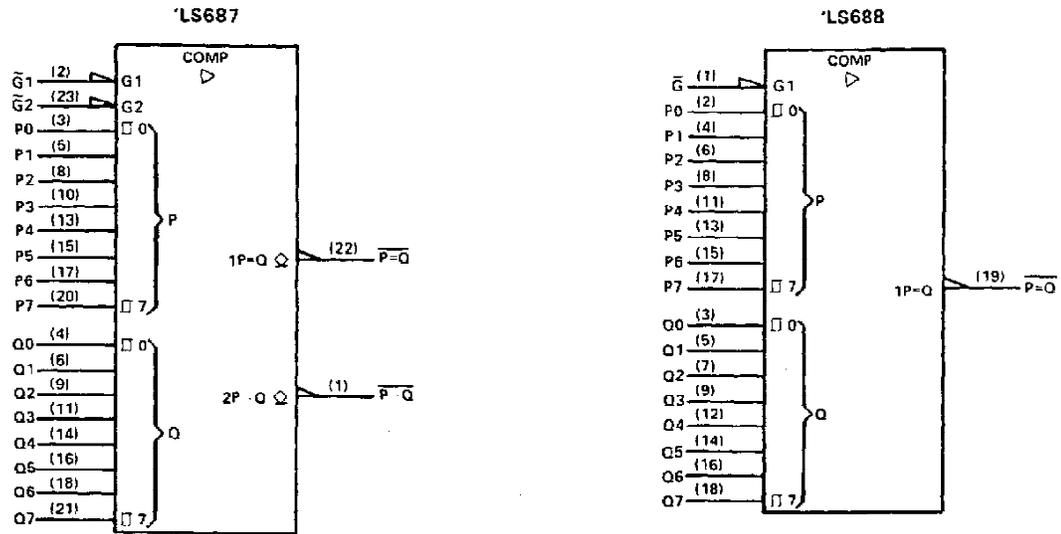
logic symbols†



†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, JT, N, and NT packages.

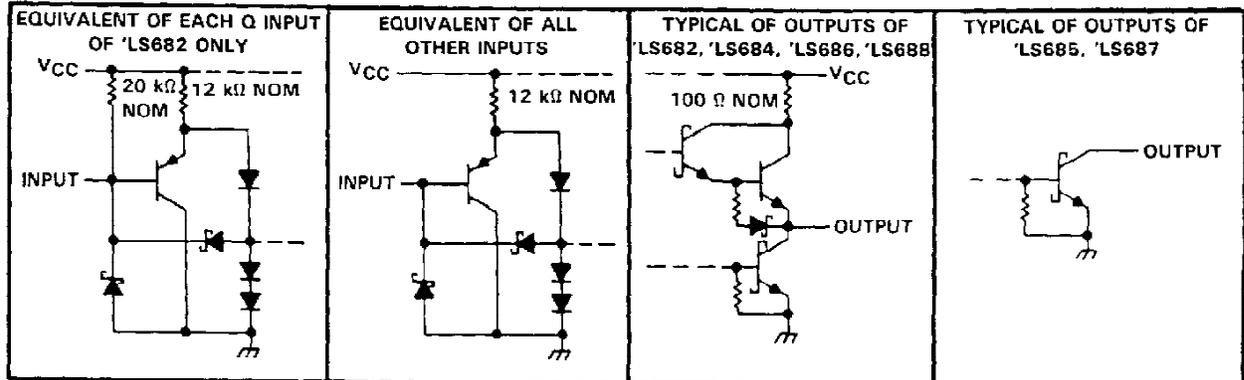
**SN54LS682, SN54LS684, SN54LS685, SN54LS687, SN54LS688,
SN74LS682, SN74LS684 THRU SN74LS688
8-BIT MAGNITUDE/IDENTITY COMPARATORS**

logic symbols† (continued)



†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, JT, N, and NT packages.

schematics of inputs and outputs

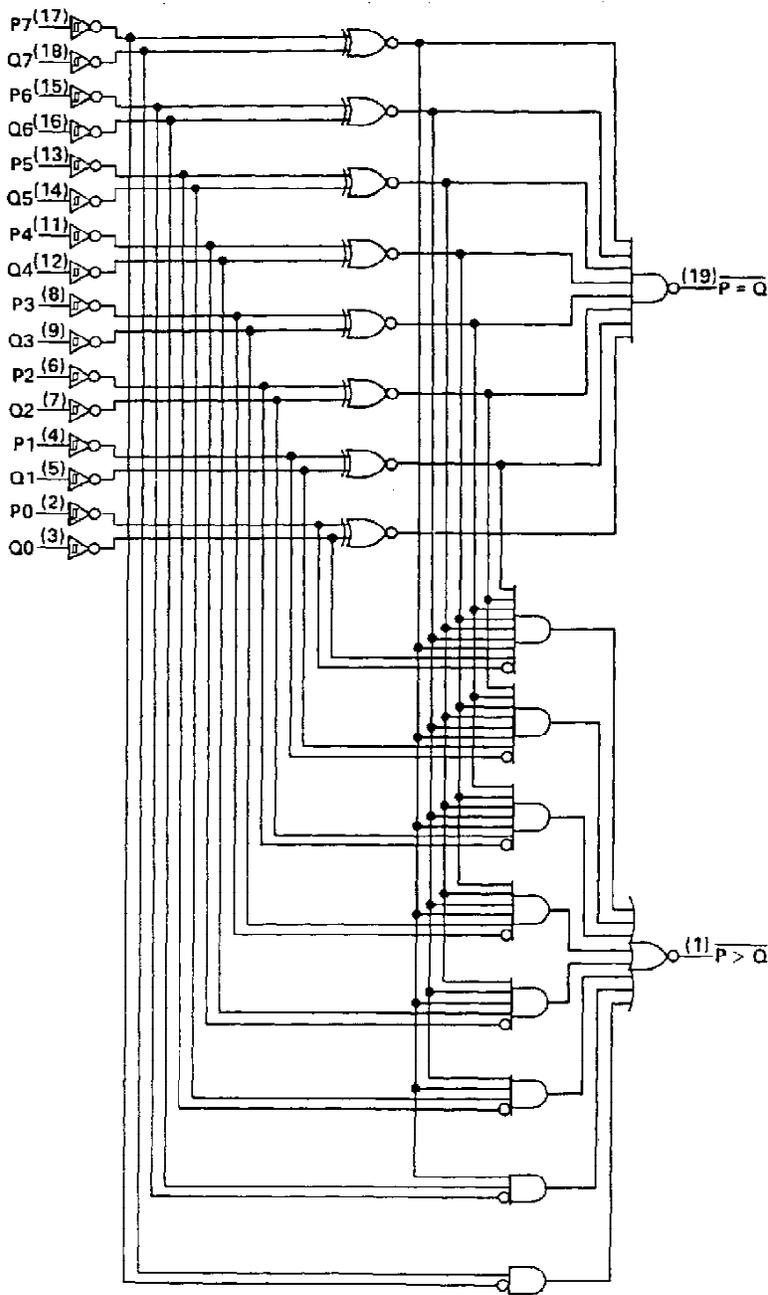


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**SN54LS682, SN54LS684, SN54LS685
 SN74LS682, SN74LS684, SN74LS685
 8-BIT MAGNITUDE/IDENTITY COMPARATORS**

LS682, LS684, LS685 logic diagram (positive logic)



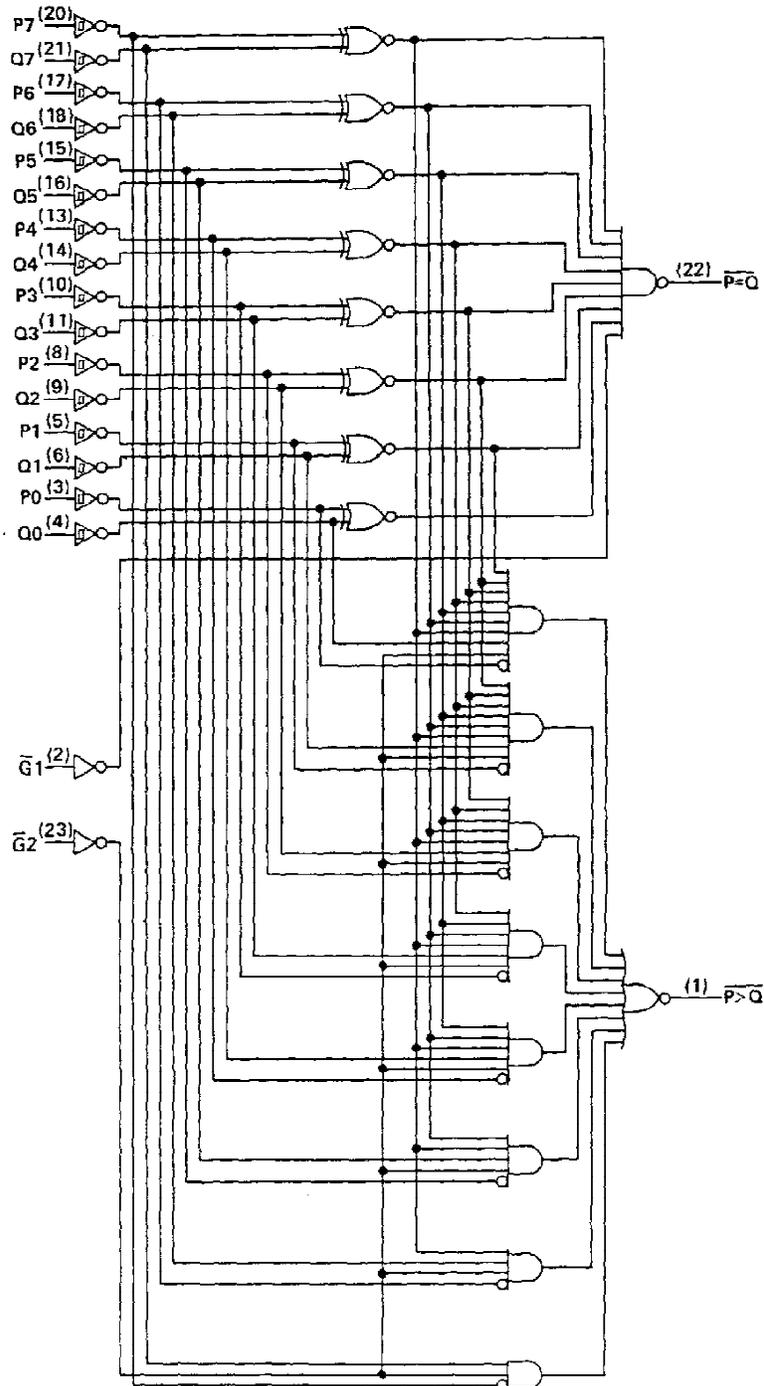
Pin numbers shown are for DW, J, and N packages.

TEXAS 
INSTRUMENTS

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SN54LS687
SN74LS686, SN74LS687
8-BIT MAGNITUDE/IDENTITY COMPARATORS

'LS686, 'LS687 logic diagram (positive logic)



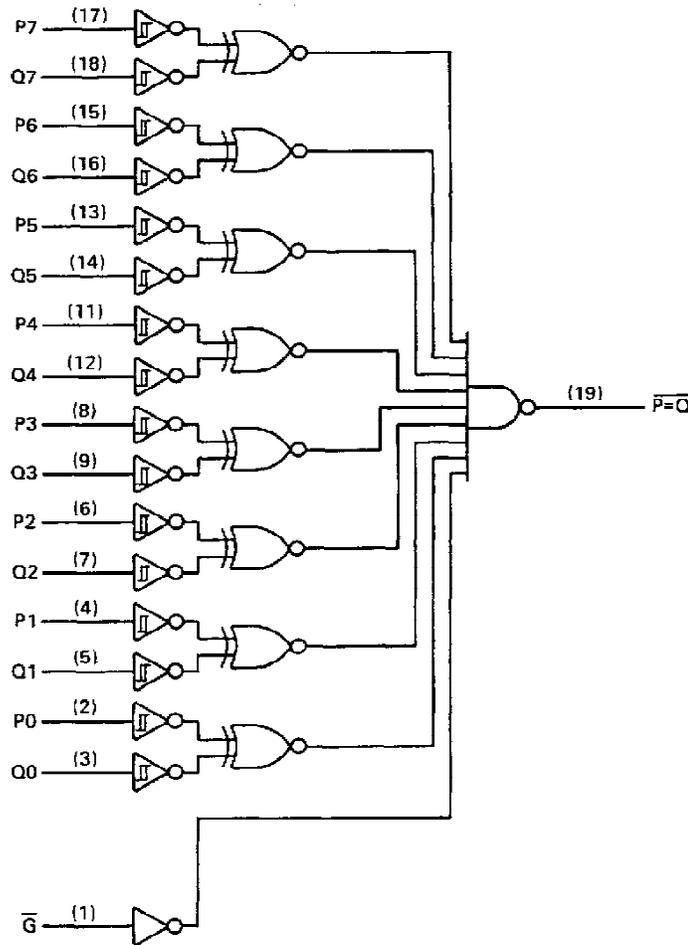
Pin numbers shown are for DW, JT, and NT packages.

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**SN54LS682, SN54LS684, SN54LS685, SN54LS687, SN54LS688
SN74LS682, SN74LS684 THRU SN74LS688
8-BIT IDENTITY COMPARATORS**

'LS688 logic diagram (positive logic)



Pin numbers shown are for DW, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage: Q inputs of 'LS682	5.5 V
All other inputs	7 V
Off-state output voltage: 'LS685, 'LS687	7 V
Operating free-air temperature range:	
SN54LS682, SN54LS684, SN54LS685, SN54LS687, SN54LS688	-55 °C to 125 °C
SN74LS682, SN74LS684 thru SN74LS688	0 °C to 70 °C
Storage temperature range	-65 °C to 150 °C

NOTE 1: Voltage values are with respect to network ground terminal.



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**SN54LS682, SN54LS684, SN54LS688
SN74LS682, SN74LS684, SN74LS686, SN74LS688
8-BIT MAGNITUDE/IDENTITY COMPARATORS WITH TOTEM-POLE OUTPUTS**

recommended operating conditions

	SN54LS'			SN74LS'			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.85	5	5.25	V
High-level output current, I_{OH}			-400			-400	μ A
Low-level output current, I_{OL}			12			24	mA
Operating free-air temperature, T_A	-55		125	0		70	$^{\circ}$ C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN54LS'		SN74LS'		UNIT	
			MIN	TYP‡	MAX	MIN		TYP‡
V_{IH}	High-level input voltage		2		2		V	
V_{IL}	Low-level input voltage			0.7		0.8	V	
$V_{T+} - V_{T-}$	Hysteresis	P or Q inputs		0.4		0.4	V	
V_{IK}	Input clamp voltage	$V_{CC} = \text{MIN}$				-1.5	V	
V_{OH}	High-level output voltage	$V_{CC} = \text{MIN}$, $V_{IH} = 2 \text{ V}$, $V_{IL} = V_{IL\text{max}}$, $I_{OH} = -400 \mu\text{A}$	2.5		2.7		V	
V_{OL}	Low-level output voltage	$V_{CC} = \text{MIN}$, $V_{IH} = 2 \text{ V}$, $V_{IL} = V_{IL\text{max}}$	$I_{OL} = 12 \text{ mA}$	0.25	0.4	0.25	0.4	V
			$I_{OL} = 24 \text{ mA}$			0.35	0.5	
I_I	Input current at maximum input voltage	Q inputs, 'LS682	$V_{CC} = \text{MAX}$, $V_I = 5.5 \text{ V}$					mA
		All other inputs	$V_{CC} = \text{MAX}$, $V_I = 7 \text{ V}$		0.1		0.1	
I_{IH}	High-level input current		$V_{CC} = \text{MAX}$, $V_I = 2.7 \text{ V}$		20		20	μ A
I_{IL}	Low-level input current	Q inputs, 'LS682	$V_{CC} = \text{MAX}$, $V_I = 0.4 \text{ V}$		-0.4		-0.4	mA
		All other inputs			-0.2		-0.2	
I_{OS}^{\S}	Short-circuit output current		$V_{CC} = \text{MAX}$, $V_O = 0$	-20	-100	-20	-100	mA
I_{CC}	Supply current	'LS682	$V_{CC} = \text{MAX}$, See Note 1	42	70	42	70	mA
		'LS684		40	65	40	65	
		'LS686		44	75	44	75	
		'LS688		40	65	40	65	

† For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 1: I_{CC} is measured with any \bar{Q} inputs grounded, all other inputs at 4.5 V, and all outputs open.

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SN54LS682, SN54LS684, SN54LS688
SN74LS682, SN74LS684, SN74LS686, SN74LS688
8-BIT MAGNITUDE/IDENTITY COMPARATORS WITH TOTEM-POLE OUTPUTS

switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER†	FROM (INPUTS)	TO (OUTPUT)	TEST CONDITIONS	'LS682		'LS684		'LS686		'LS688		UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	
t_{PLH}	P	$\overline{P=Q}$	$R_L = 667\ \Omega$, $C_L = 45\ \text{pF}$, All other inputs low, See Note 2	13	25	15	25	13	25	12	18	ns
t_{PHL}				15	25	17	25	20	30	17	23	
t_{PLH}	Q	$\overline{P=Q}$		14	25	16	25	13	25	12	18	ns
t_{PHL}				15	25	15	25	21	30	17	23	
t_{PLH}	$\overline{Q}, \overline{Q}1$	$\overline{P=Q}$						11	20	12	18	ns
t_{PHL}								19	30	13	20	
t_{PLH}	P	$\overline{P>Q}$				20	30	22	30	19	30	ns
t_{PHL}						15	30	17	30	15	30	
t_{PLH}	Q	$\overline{P>Q}$				21	30	24	30	18	30	ns
t_{PHL}						19	30	20	30	19	30	
t_{PLH}	$\overline{Q}2$	$\overline{P>Q}$							21	30		ns
t_{PHL}										16	25	

† t_{PLH} = propagation delay time, low-to-high-level outputs; t_{PHL} = propagation delay time, high-to-low-level output.
 NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

SN54LS685, SN54LS687
SN74LS685, SN74LS687, SN74LS688

8-BIT MAGNITUDE/IDENTITY COMPARATORS WITH TOTEM-POLE OUTPUTS

recommended operating conditions

	SN54LS [†]			SN74LS [†]			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.85	5	5.25	V
High-level output current, I_{OH}			5.5			5.5	V
Low-level output current, I_{OL}			12			24	mA
Operating free-air temperature, T_A	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS [†]	SN54LS [†]			SN74LS [†]			UNIT		
			MIN	TYP	MAX	MIN	TYP	MAX			
V_{IH}	High-level input voltage		2			2			V		
V_{IL}	Low-level input voltage				0.7			0.8	V		
$V_{T+} - V_{T-}$	Hysteresis	P or Q inputs	$V_{CC} = \text{MIN}$			0.4			V		
V_{IK}	Input clamp voltage		$V_{CC} = \text{MIN}, I_I = -18 \text{ mA}$			-1.5			V		
I_{OH}	High-level output voltage		$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = V_{ILmax}, V_{OH} = 5.5 \text{ V}$			250			μA		
V_{OL}	Low-level output voltage		$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = V_{ILmax}$			$I_{OL} = 12 \text{ mA}$			0.25	0.4	V
						$I_{OL} = 24 \text{ mA}$			0.35	0.5	
I_I			$V_{CC} = \text{MAX}, V_I = 7 \text{ V}$			0.1			0.1	mA	
I_{IH}	High-level input current		$V_{CC} = \text{MAX}, V_I = 2.7 \text{ V}$			20			20	μA	
I_{IL}	Low-level input current		$V_{CC} = \text{MAX}, V_I = 0.4 \text{ V}$			-0.2			-0.2	mA	
I_{CC}	Supply current	'LS685	$V_{CC} = \text{MAX},$ See Note 1			40			65	mA	
		'LS687				44			75		

[†]For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions.

[‡]All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

NOTE 1: I_{CC} is measure with any \bar{Q} inputs grounded, all other inputs at 4.5 V, and all outputs open.



SN54LS685, SN54LS687
SN74LS685, SN74LS687
8-BIT MAGNITUDE/IDENTITY COMPARATORS WITH OPEN-COLLECTOR OUTPUTS

switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS685			'LS687			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
t_{PLH}	P	$\overline{P=Q}$	$R_L = 667\ \Omega$, $C_L = 45\ \text{pF}$, All other inputs low, See Note 2	30	45		24	35	ns	
t_{PHL}				19	35		20	30		
t_{PLH}	Q	$\overline{P=Q}$		24	45		24	35	ns	
t_{PHL}				23	35		20	30		
t_{PLH}	$\overline{Q}, \overline{Q1}$	$\overline{P=Q}$					21	35	ns	
t_{PHL}							18	30		
t_{PLH}	P	$\overline{P>Q}$			32	45		24	35	ns
t_{PHL}					16	35		16	30	
t_{PLH}	Q	$\overline{P>Q}$			30	45		24	35	ns
t_{PHL}					20	35		16	30	
t_{PLH}	$\overline{Q2}$	$\overline{P>Q}$				24	35	ns		
t_{PHL}						15	30			

t_{PLH} = propagation delay time, low-to-high-level outputs; t_{PHL} = propagation delay time, high-to-low-level output.
 NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



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